

/ Descriptions

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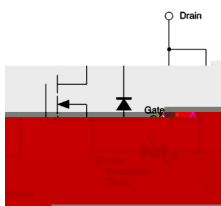
/ Features

500V HBM

HBM

/ Applications

/ Equivalent Circuit



/ Pinning



/ Marking

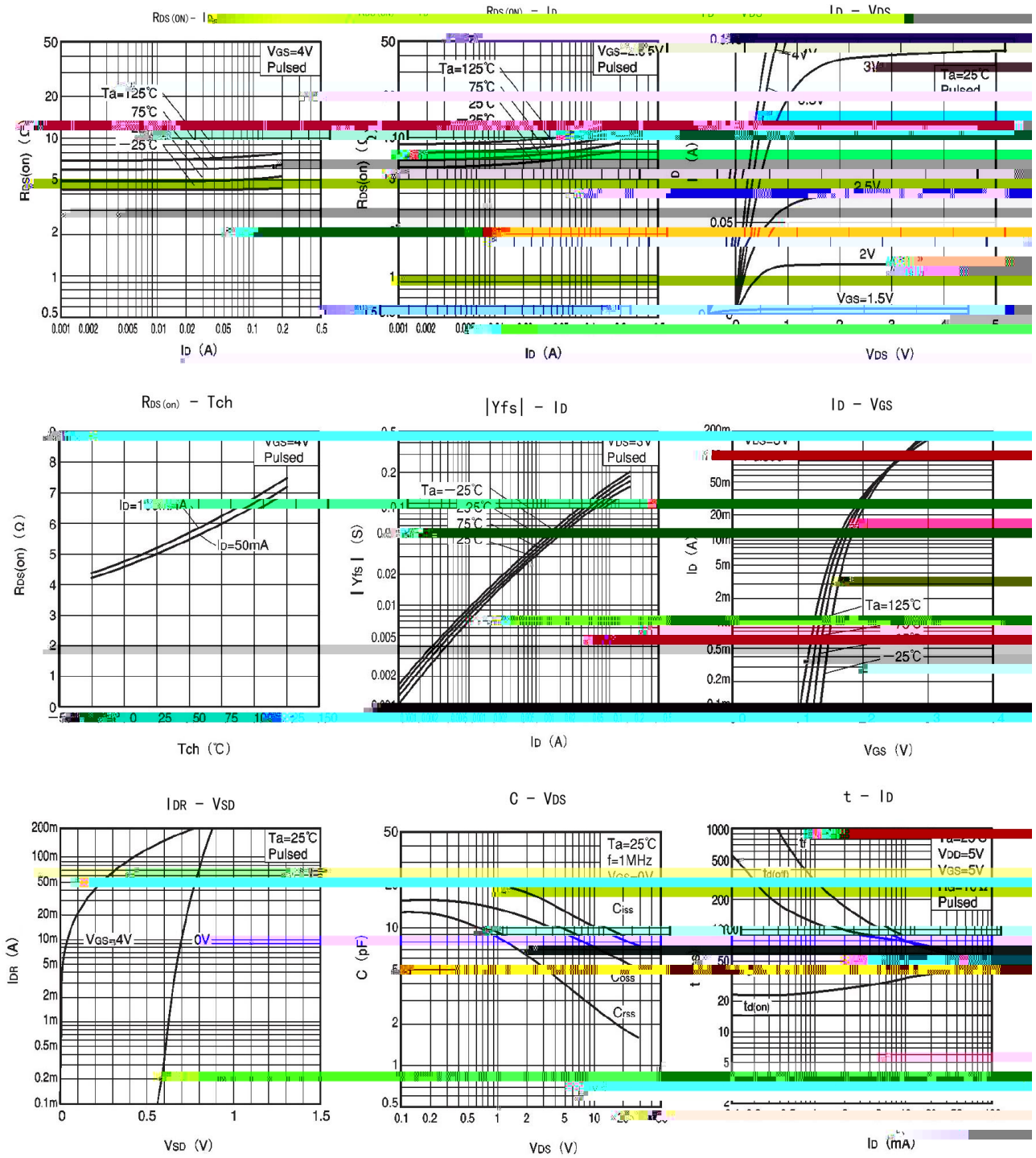
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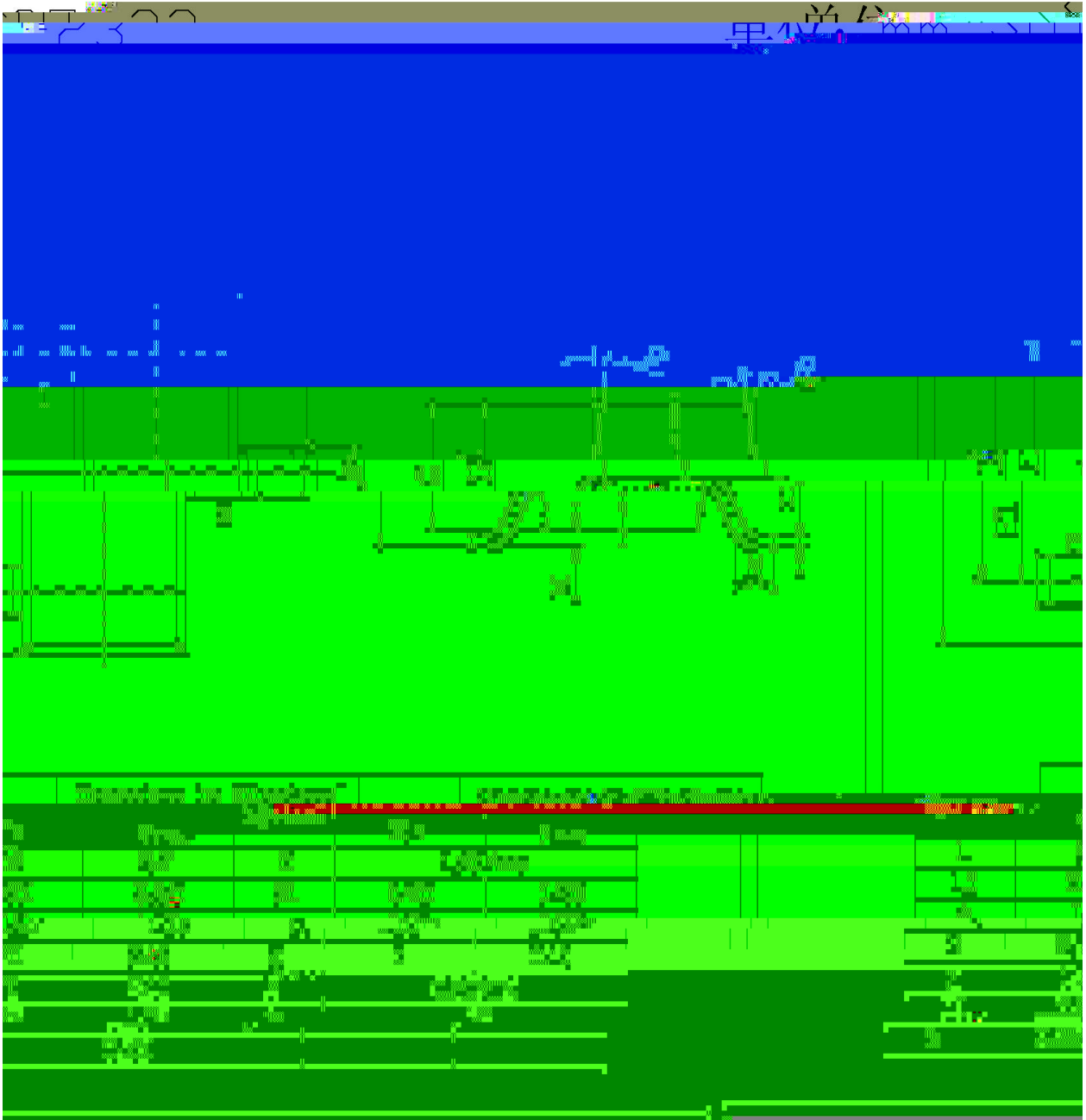


DATA SHEET

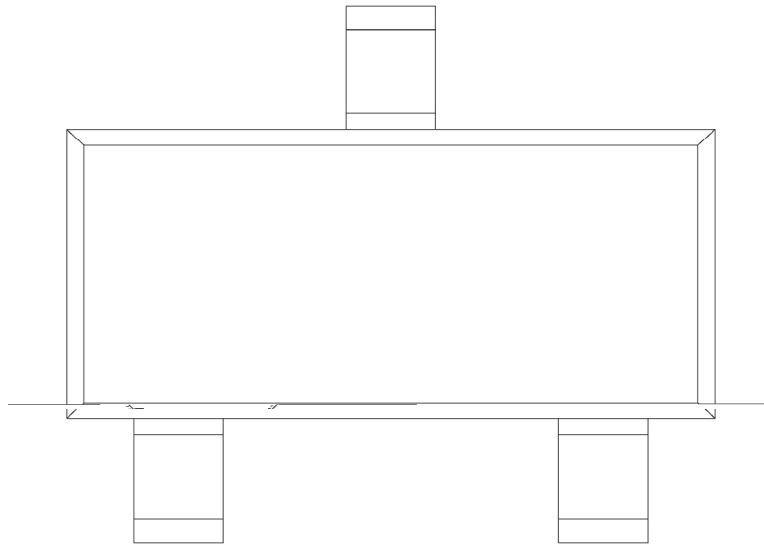
/ Electrical Characteristic Curve



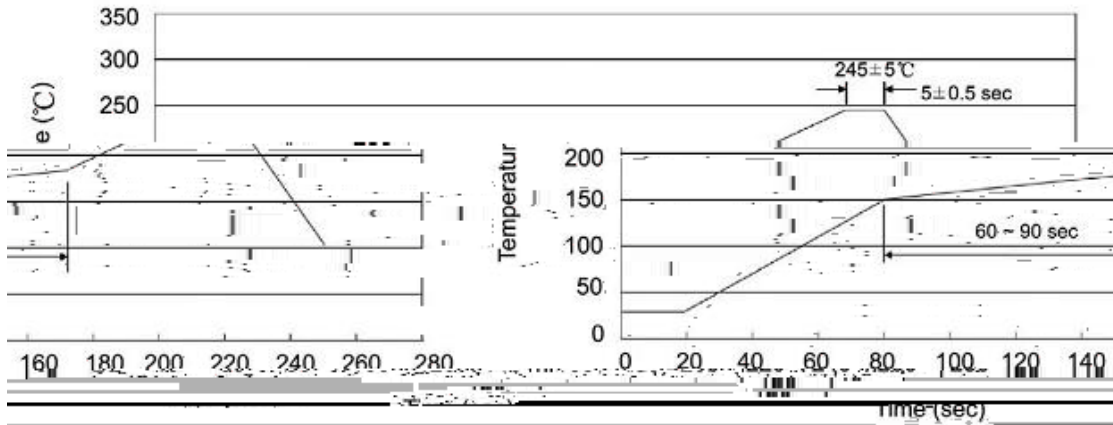
/ Package Dimensions



/ Marking Instructions



() / Temperature Profile for IR Reflow Soldering (Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ± ± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只卷盘	卷盘盒	只盒	盒箱	只箱	盒	箱	

/ Notices